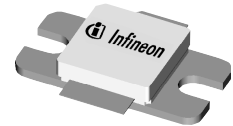


## Thermally-Enhanced High Power RF LDMOS FETs 70 W, 1805 – 1880 MHz

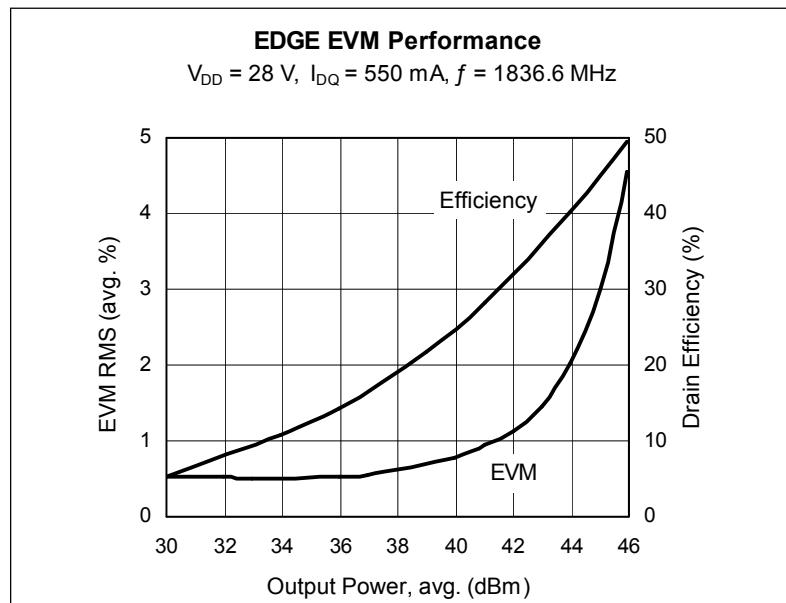
### Description

The PTFA180701E and PTFA180701F are 70-watt LDMOS FETs designed for GSM and GSM EDGE power amplifier applications in the 1805 MHz to 1880 MHz band. Features include input and output matching, and thermally-enhanced packages with slotted or earless flanges. Manufactured with Infineon's advanced LDMOS process, these devices provide excellent thermal performance and superior reliability.

PTFA180701E  
Package H-36265-2



PTFA180701F  
Package H-37265-2



### Features

- Thermally-enhanced packages, Pb-free and RoHS-compliant
- Broadband internal matching
- Typical EDGE performance
  - Average output power = 44 dBm
  - Gain = 16.5 dB
  - Efficiency = 40.5%
  - EVM = 2.0%
- Typical CW performance
  - Output power at P-1dB = 72 W
  - Gain = 15.5 dB
  - Efficiency = 59%
- Integrated ESD protection: Human Body Model, Class 2 (minimum)
- Excellent thermal stability, low HCI drift
- Capable of handling 10:1 VSWR @ 28 V, 70 W (CW) output power

### RF Characteristics

**EDGE Measurements** (not subject to production test—verified by design/characterization in Infineon test fixture)

$V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 550\text{ mA}$ ,  $P_{OUT} = 44\text{ dBm}$ ,  $f = 1836.6\text{ MHz}$

Characteristic		Symbol	Min	Typ	Max	Unit
Error Vector Magnitude		EVM RMS	—	2.0	—	%
Modulation Spectrum	@ 400 kHz	ACPR	—	-62	—	dBc
	@ 600 kHz	ACPR	—	-76	—	dBc
Gain		$G_{ps}$	—	16.5	—	dB
Drain Efficiency		$\eta_D$	—	40.5	—	%

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

**ESD:** Electrostatic discharge sensitive device—observe handling precautions!

## RF Characteristics (cont.)

### Two-tone Measurements (tested in Infineon test fixture)

$V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 550\text{ mA}$ ,  $P_{OUT} = 60\text{ W PEP}$ ,  $f = 1840\text{ MHz}$ , tone spacing = 1 MHz

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	$G_{ps}$	15.5	16.5	—	dB
Drain Efficiency	$\eta_D$	44	45	—	%
Intermodulation Distortion	IMD	—	-30	-29	dBc

## DC Characteristics

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$ , $I_{DS} = 10\text{ mA}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$
	$V_{DS} = 63\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	10.0	$\mu\text{A}$
On-State Resistance	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.125	—	$\Omega$
Operating Gate Voltage	$V_{DS} = 28\text{ V}$ , $I_D = 550\text{ mA}$	$V_{GS}$	2.0	2.5	3.0	V
Gate Leakage Current	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0\text{ V}$	$I_{GSS}$	—	—	1.0	$\mu\text{A}$

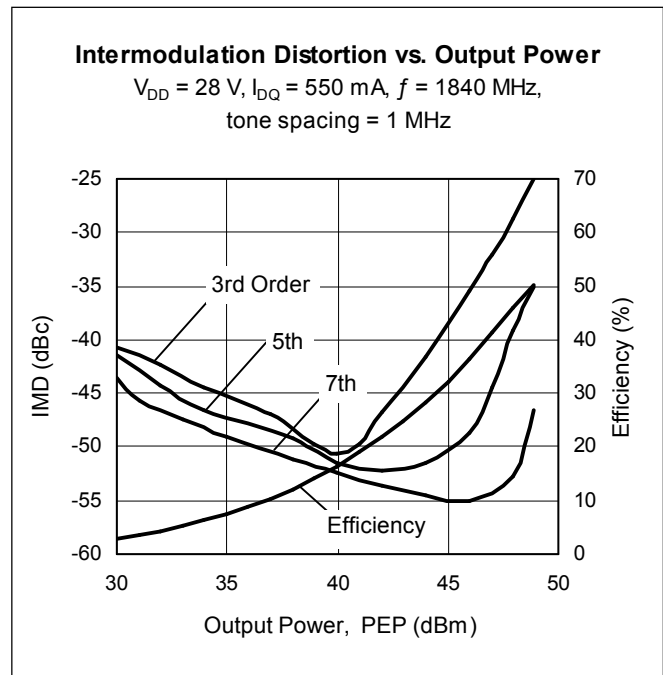
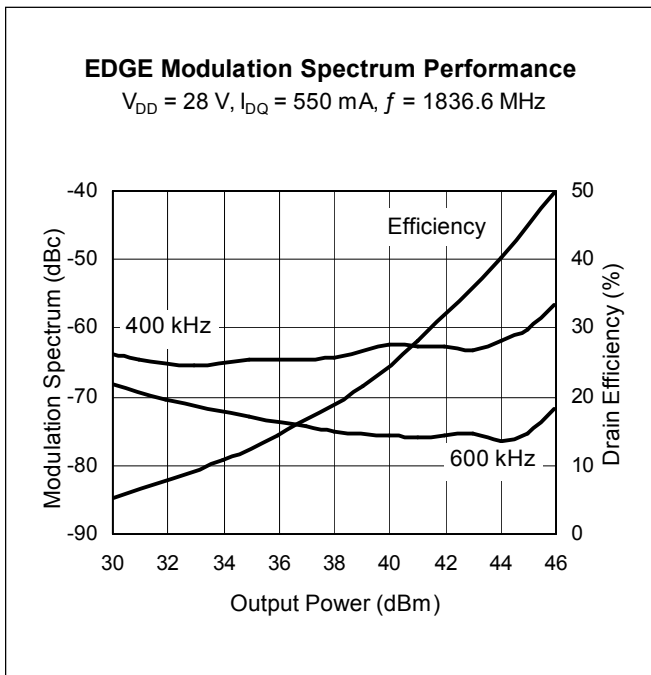
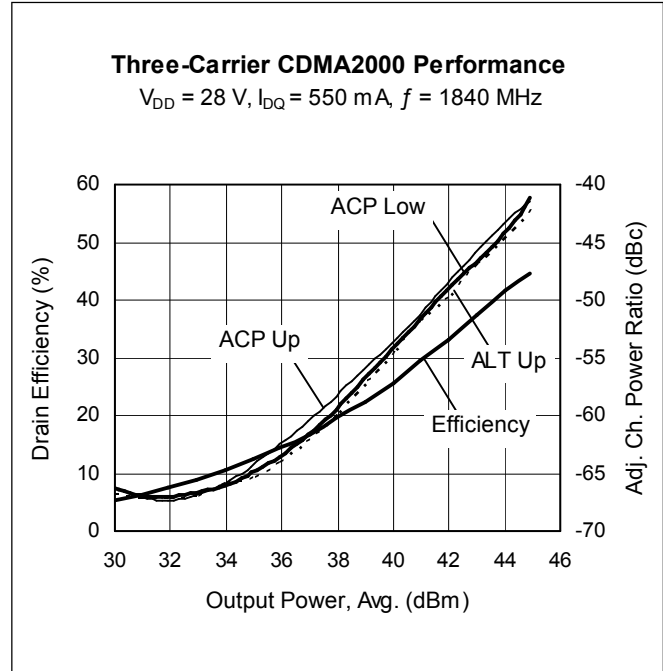
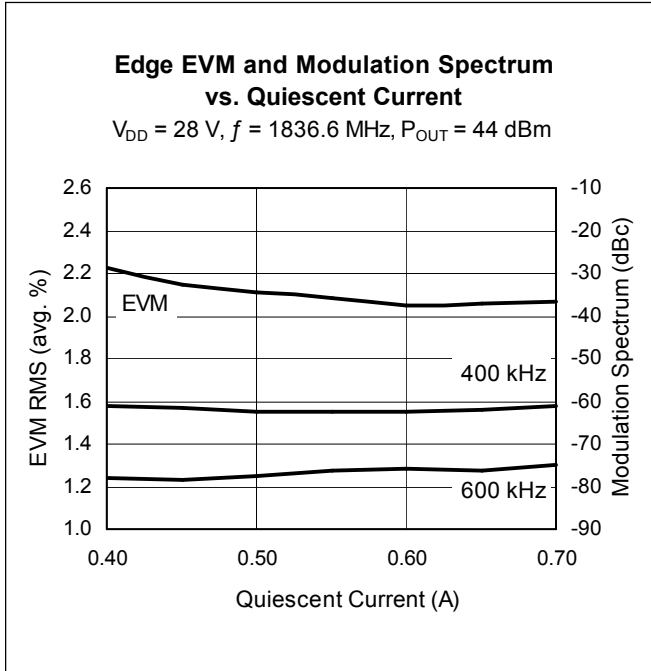
## Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	V
Gate-Source Voltage	$V_{GS}$	-0.5 to +12	V
Junction Temperature	$T_J$	200	$^{\circ}\text{C}$
Total Device Dissipation Above 25 $^{\circ}\text{C}$ derate by	$P_D$	201	W
		1.15	W/ $^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-40 to +150	$^{\circ}\text{C}$
Thermal Resistance ( $T_{CASE} = 70^{\circ}\text{C}$ , 70 W CW)	$R_{\theta JC}$	0.87	$^{\circ}\text{C}/\text{W}$

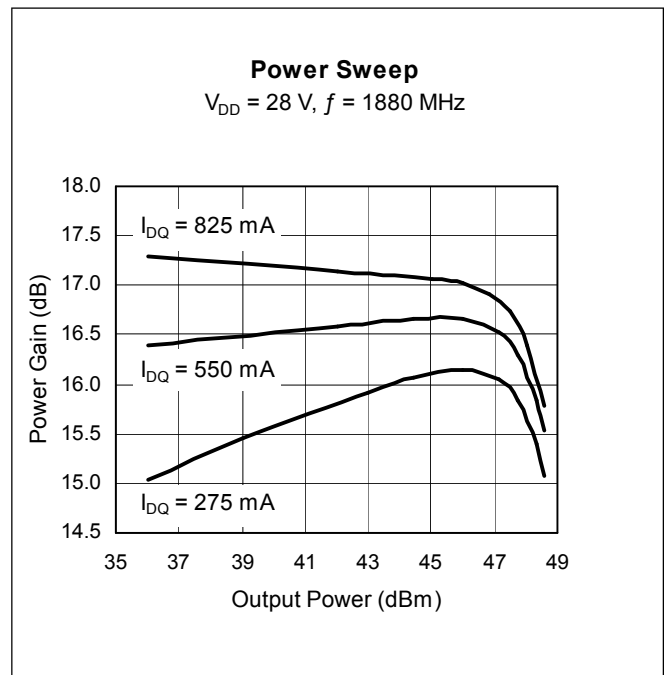
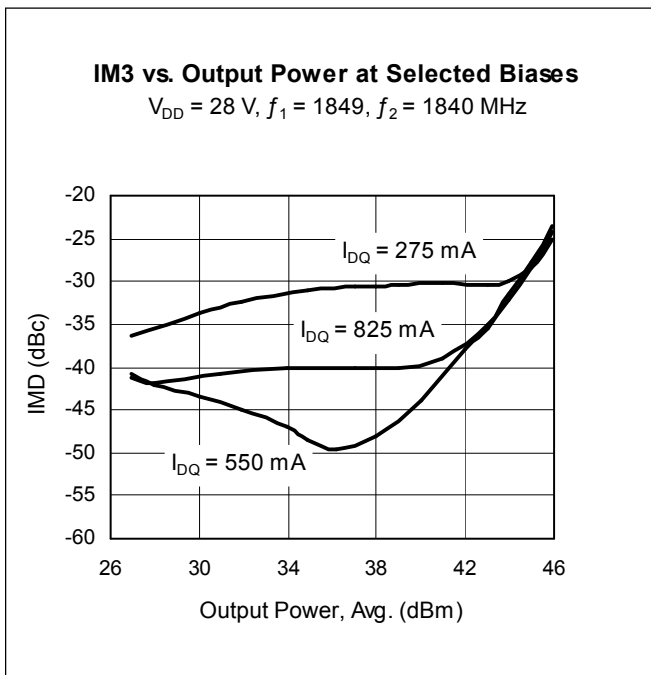
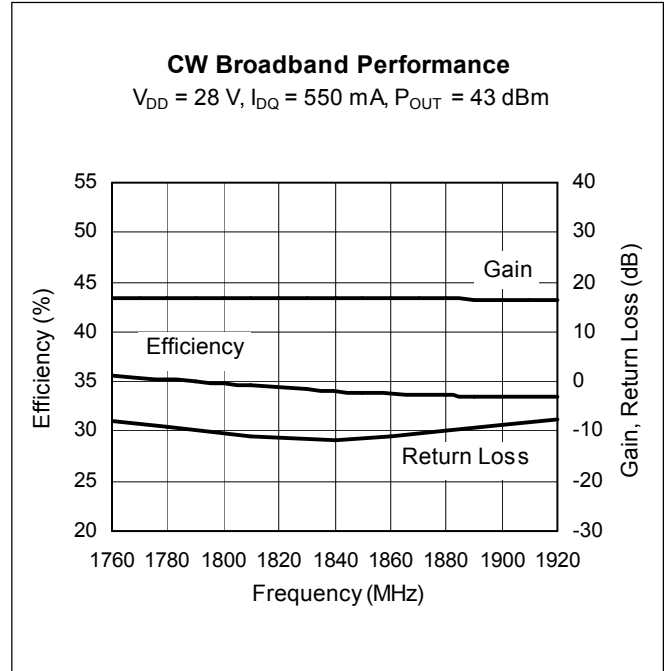
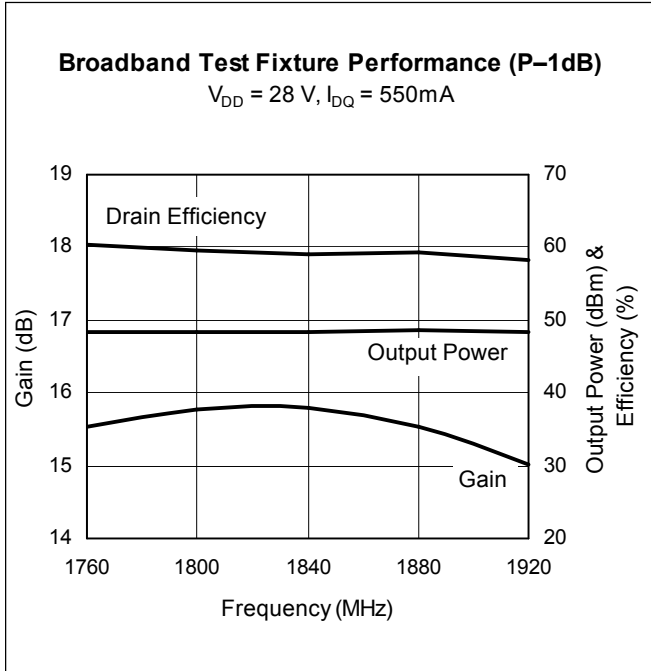
## Ordering Information

Type and Version	Order Code	Package Description	Shipping
PTFA180701E V4 R0	PTFA180701EV4R0XTMA1	H-36265-2, bolt-down	Tape & Reel, 50 pcs
PTFA180701E V4 R250	PTFA180701EV4R250XTMA1	H-36265-2, bolt-down	Tape & Reel, 250 pcs
PTFA180701F V4 R0	PTFA180701FV4R0XTMA1	H-37265-2, earless flange	Tape & Reel, 50 pcs
PTFA180701F V4 R250	PTFA180701FV4R250XTMA1	H-37265-2, earless flange	Tape & Reel, 250 pcs

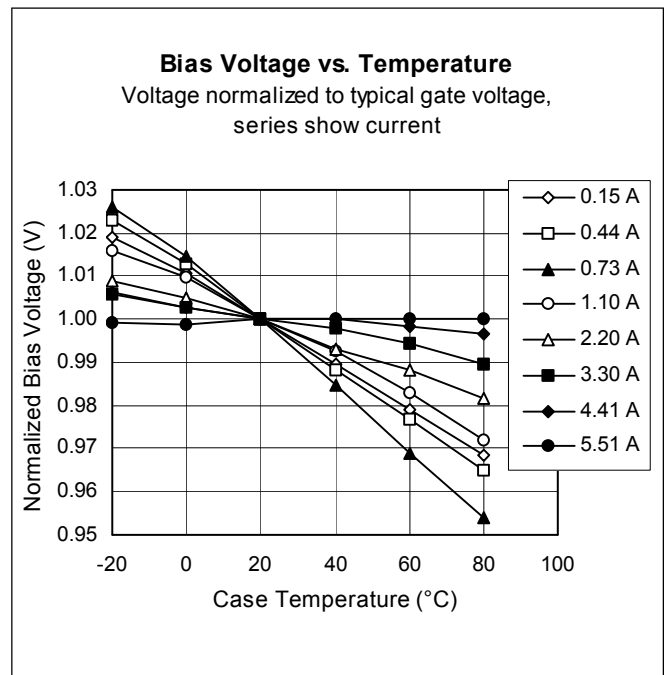
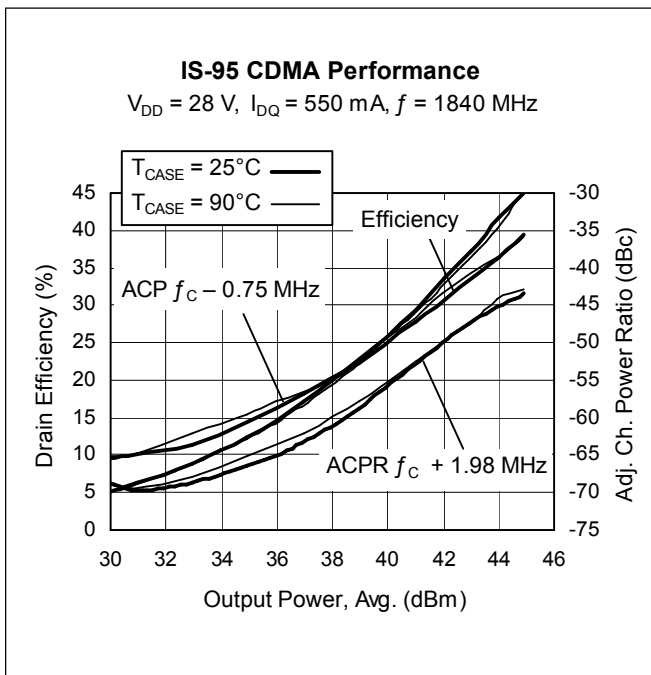
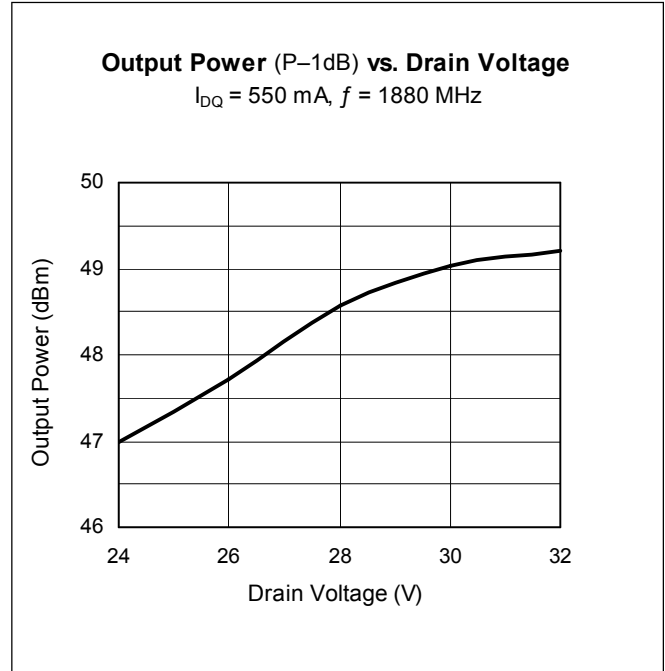
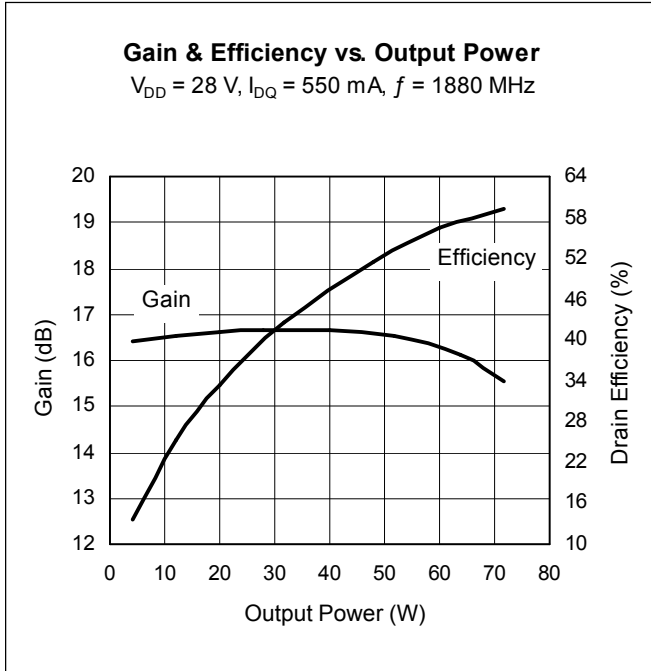
**Typical Performance** (measurements taken in production test fixture)



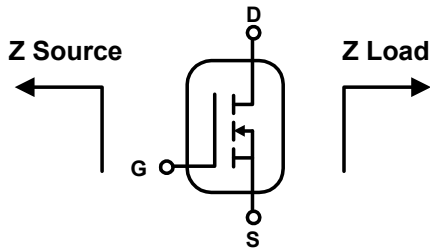
**Typical Performance (cont.)**



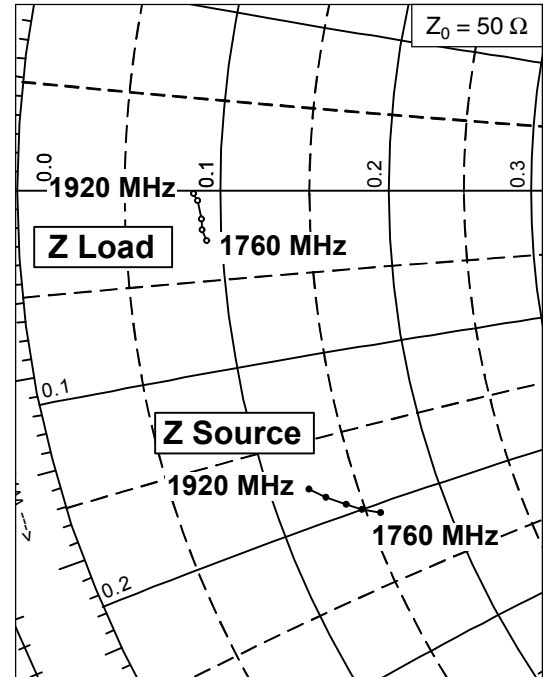
Typical Performance (cont.)



### Broadband Circuit Impedance

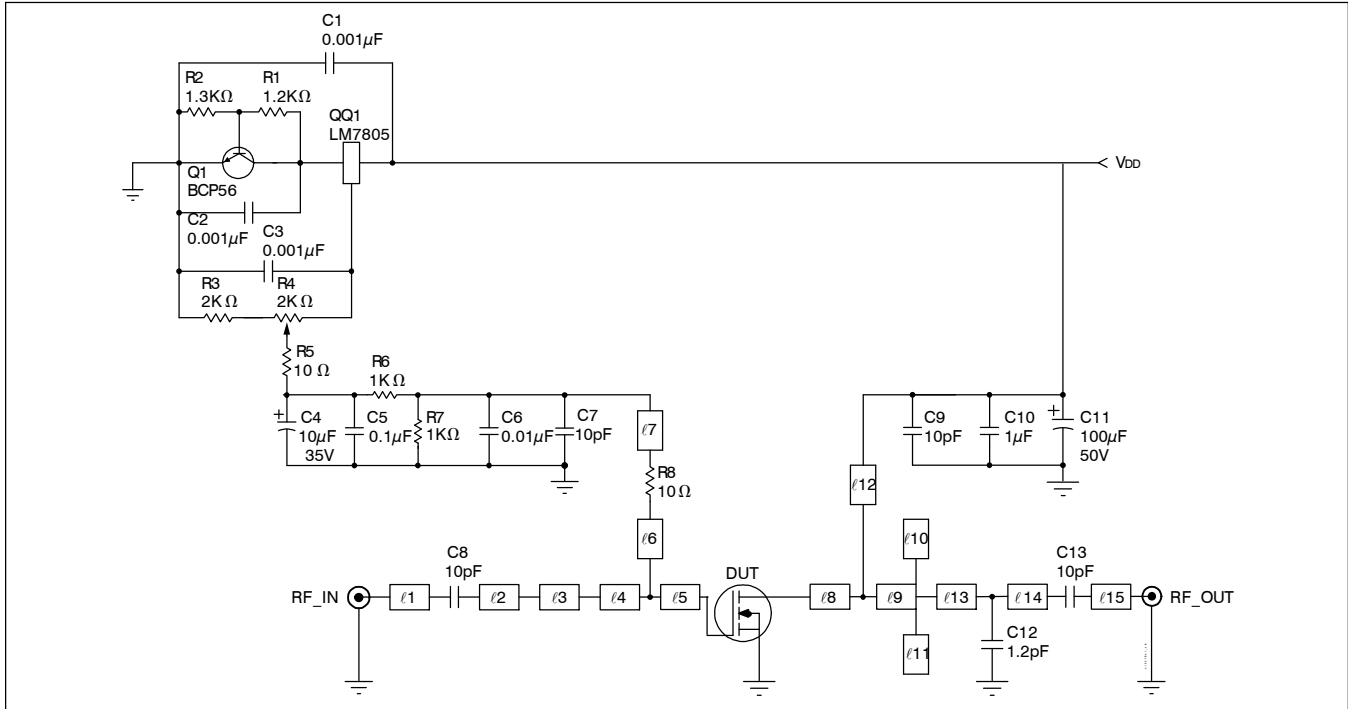


Frequency MHz	Z Source W		Z Load W	
	R	jX	R	jX
1760	7.9	-10.3	4.6	-1.4
1800	7.4	-10.0	4.5	-1.1
1840	7.0	-9.7	4.5	-0.8
1880	6.5	-9.3	4.4	-0.3
1920	6.1	-8.9	4.3	-0.1



See next page for circuit information

## Reference Circuit



Reference circuit schematic for 1840 MHz

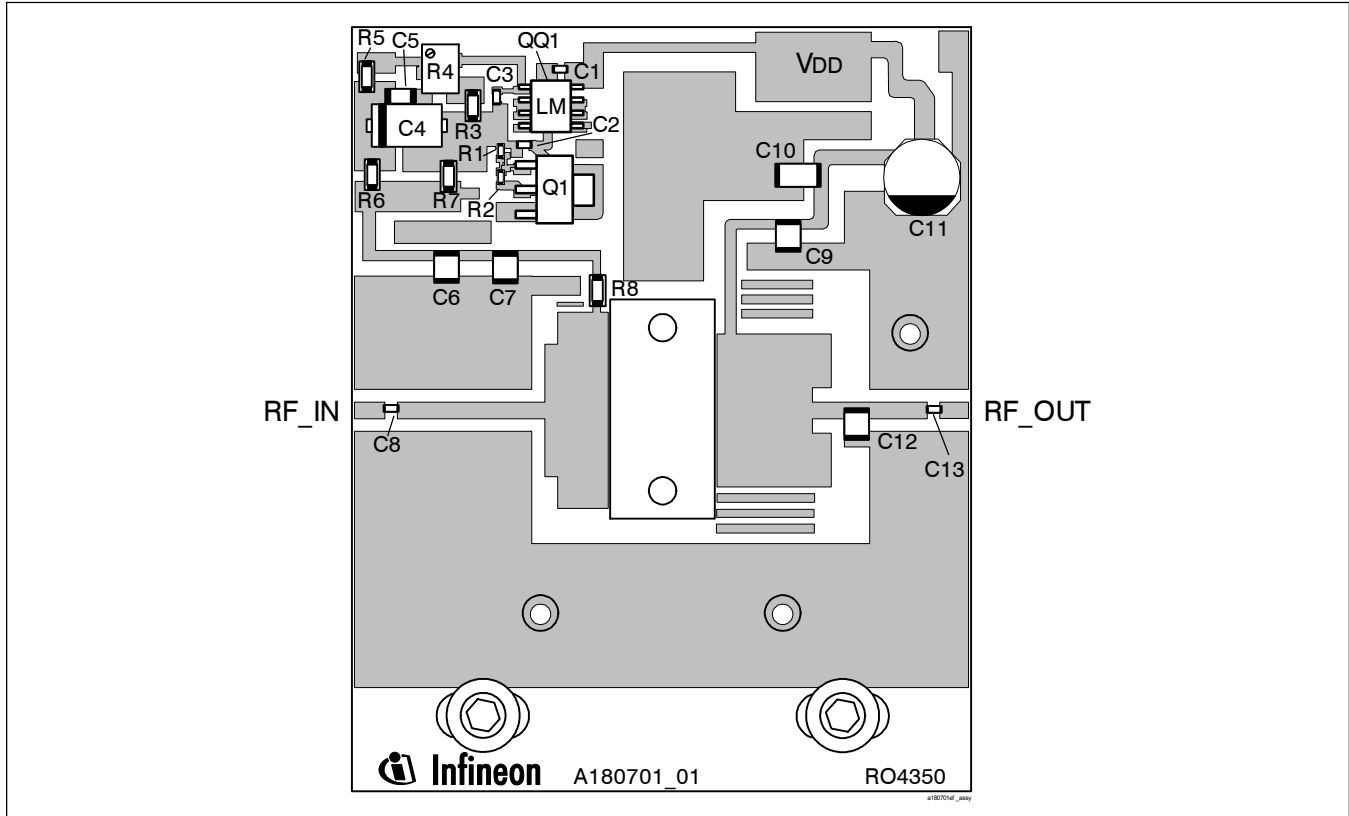
### Circuit Assembly Information

DUT	PTFA180701E or PTFA180701F	LDMOS Transistor	
PCB	0.76 mm [.030"], $\epsilon_r = 3.48$	Rogers, RO4350	1 oz. copper

Microstrip	Electrical Characteristics at 1840 MHz <sup>1</sup>	Dimensions: L x W ( mm )	Dimensions: L x W (in.)
$\ell_1$	0.034 $\lambda$ , 50.0	3.33 x 1.70	0.131 x 0.067
$\ell_2$	0.149 $\lambda$ , 50.0	14.68 x 1.70	0.578 x 0.067
$\ell_3$	0.014 $\lambda$ , 10.2	1.27 x 13.28	0.050 x 0.523
$\ell_4$	0.044 $\lambda$ , 7.1	3.86 x 19.61	0.152 x 0.772
$\ell_5$	0.014 $\lambda$ , 7.1	1.27 x 19.61	0.050 x 0.772
$\ell_6$	0.012 $\lambda$ , 78.0	1.22 x 0.74	0.048 x 0.029
$\ell_7$	0.115 $\lambda$ , 65.0	11.51 x 1.07	0.453 x 0.042
$\ell_8$	0.016 $\lambda$ , 8.9	1.37 x 15.34	0.054 x 0.604
$\ell_9$	0.090 $\lambda$ , 8.9	8.13 x 15.34	0.320 x 0.604
$\ell_{10}, \ell_{11}$	0.020 $\lambda$ , 21.8	1.91 x 5.36	0.075 x 0.211
$\ell_{12}$	0.162 $\lambda$ , 64.0	16.18 x 1.12	0.637 x 0.044
$\ell_{13}$	0.042 $\lambda$ , 50.0	4.11 x 1.70	0.162 x 0.067
$\ell_{14}$	0.074 $\lambda$ , 50.0	7.29 x 1.70	0.287 x 0.067
$\ell_{15}$	0.032 $\lambda$ , 50.0	3.12 x 1.70	0.123 x 0.067

<sup>1</sup>Electrical characteristics are rounded

Reference Circuit (cont.)



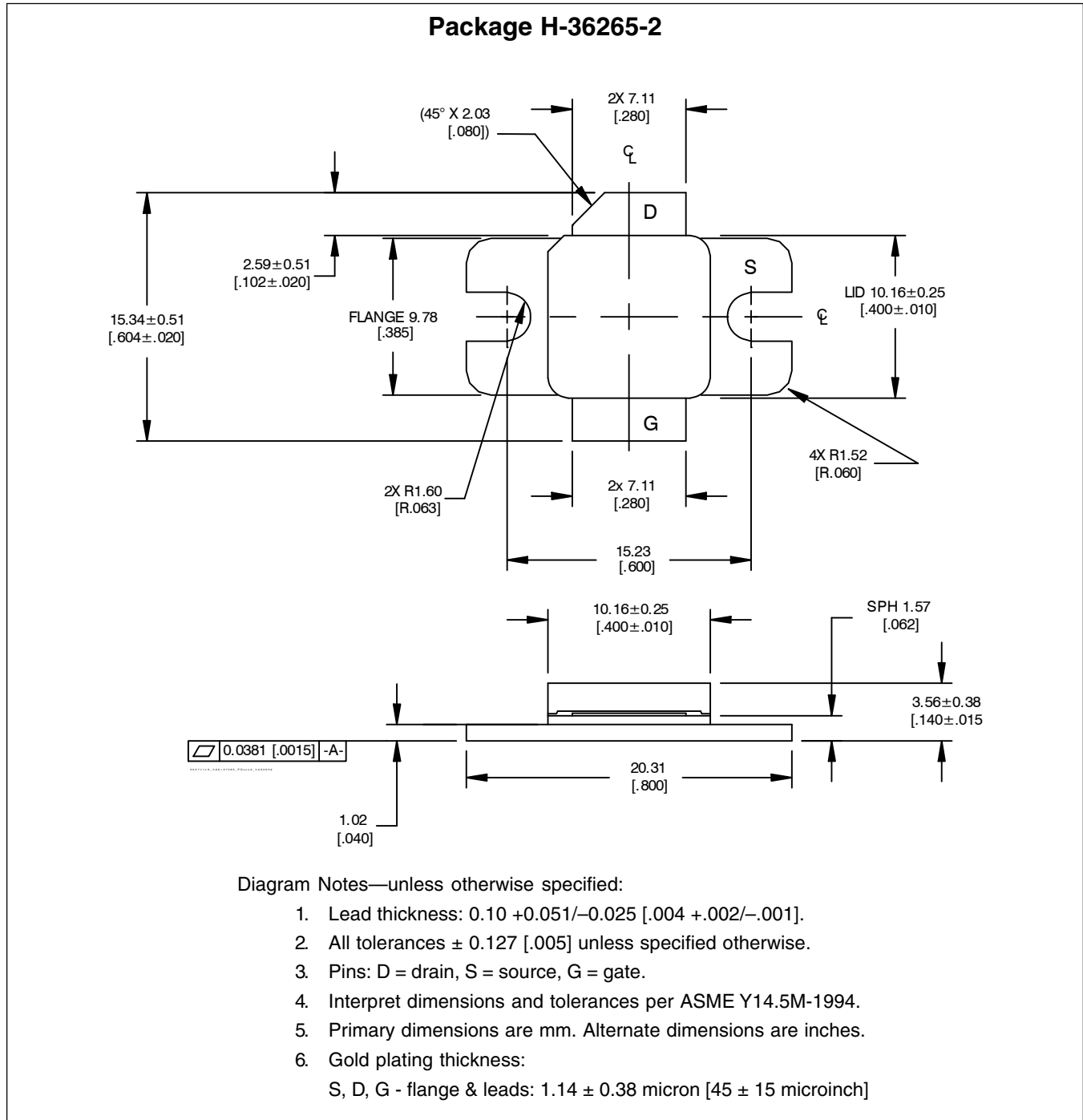
Reference circuit assembly diagram\* (not to scale)

Component	Description	Suggested Manufacturer	P/N or Comment
C1, C2, C3	Capacitor, 0.001 $\mu$ F	Digi-Key	PCC1772CT-ND
C4	Tantalum capacitor, 10 $\mu$ F, 35 V	Digi-Key	399-1655-2-ND
C5	Capacitor, 0.1 $\mu$ F	Digi-Key	PCC104BCT-ND
C6	Capacitor, 0.01 $\mu$ F	ATC	200B 103
C7, C9	Ceramic capacitor, 10 pF	ATC	100B 100
C8, C13	Ceramic capacitor, 10 pF	ATC	100A 100
C10	Ceramic capacitor, 1 $\mu$ F	Digi-Key	445-1411-1-ND
C11	Electrolytic capacitor, 100 $\mu$ F, 50 V	Digi-Key	PCE3718CT-ND
C12	Ceramic capacitor, 1.2 pF	ATC	100B 1R2
Q1	Transistor	Infineon Technologies	BCP56
QQ1	Voltage regulator	National Semiconductor	LM7805
R1	Chip resistor 1.2 k-ohms	Digi-Key	P1.2KGCT-ND
R2	Chip resistor 1.3 k-ohms	Digi-Key	P1.3KGCT-ND
R3	Chip resistor 2 k-ohms	Digi-Key	P2KECT-ND
R4	Potentiometer 2 k-ohms	Digi-Key	3224W-202ETR-ND
R5, R8	Chip resistor 10 ohms	Digi-Key	P10ECT-ND
R6, R7	Chip resistor 1 k-ohms	Digi-Key	P1KECT-ND

\*Gerber files for this circuit available on request.

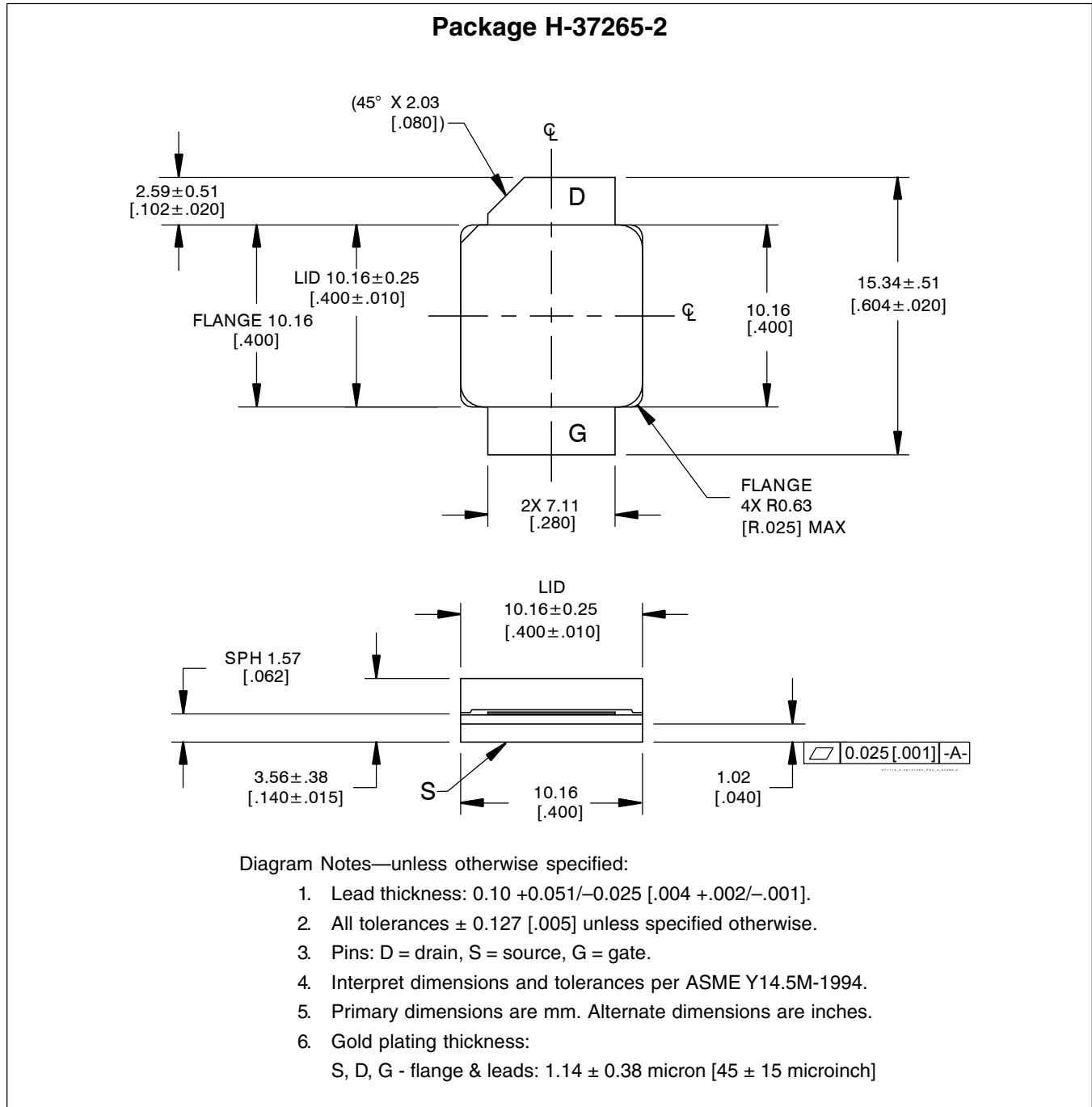


## Package Outline Specifications



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Package Outline Specifications (cont.)



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**Revision History:** 2016-06-21

Data Sheet

Previous Version: 2009-02-20, Data Sheet

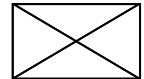
Page	Subjects (major changes since last revision)
2	Update ordering information

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